



MJ N-Channel Super Trench II Power MOSFET

Description

The series of devices uses Super Trench II technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

DC/DC Converter

General Features

- ♦ VDS=85V,ID=90A RDS(ON)=4.3mΩ, typical (TO-220)@ VGS=10V
- Excellent gate charge x RDS(on) product(FOM)
- Very low on-resistance RDS(on)
- 150°C operating temperature
- Pb-free lead plating

Schematic Diagram



Ideal for high-frequency switching and synchronous rectification

Bottom View

DFN 5X6

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJXP053N85GU	MJXP053N85GU	DFN5X6-8L	1	2	12

Absolute Maximum Ratings (Tc=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	85	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lD	90	А
Drain Current-Continuous(Tc =100°C)	ID(100℃)	70	А
Pulsed Drain Current	Ідм	360	А
Maximum Power Dissipation	PD	110	W
Derating factor		0.88	W/°C
Single pulse avalanche energy (Note 5)	Eas	599	mJ
Operating Junction and Storage Temperature Range	Тл,Тѕтс	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	1.14	°C/W	
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Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	I	1			1	
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I⊵=250µA	85	-	-	V
Zero Gate Voltage Drain Current	loss	Vds=85V,Vgs=0V	-	-	1	μA
Gate-Body Leakage Current	lgss	Vds=±20V,Vds=0V	-	-	±100	nA
On Characteristics (Note 3)		1		1		1
Gate Threshold Voltage	VGS(th)	Vds=Vgs ,Id=250µA	2.0	3.0	4.0	V
Drain-Source On-State Resistance	Rds(on)	Vgs=10V, Id=45A	-	4.3	5.3	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =45A	-	60	-	S
Dynamic Characteristics (Note 4)				1		1
Input Capacitance	Clss		-	3550	-	PF
Output Capacitance	Coss	V _{DS} =40V,V _{GS} =0V F=1.0MHz	-	540	-	PF
Reverse Transfer Capacitance	Crss		-	22	-	PF
Switching Characteristics (Note 4)	I	1		1	1	
Turn-on Delay Time	td(on)		-	14.5	-	nS
Turn-on Rise Time	tr	Vdd=40V,Id=45A	-	12	-	nS
Turn-Off Delay Time	td(off)	V _{GS} =10V,R _G =1.6Ω	-	35	-	nS
Turn-Off Fall Time	tr		-	13	-	nS
Total Gate Charge	Qg		-	67	-	nC
Gate-Source Charge	Qgs	VDS=40V,ID=45A VGS=10V	_	20	-	nC
Gate-Drain Charge	Qgd		_	20		nC
Drain-Source Diode Characteristics				<u> </u>	<u> </u>	<u> </u>
Diode Forward Voltage (Note 3)	Vsd	V _{GS} =0V,I _S =45A	-	-	1.2	V
Diode Forward Current (Note 2)	ls		-	-	90	A
Reverse Recovery Time	trr	Tj=25°C,IF=Is	_	66	-	nS
Reverse Recovery Charge	Qrr	di/dt= 100A/µs ^(Note 3)	-	140		nC

Notes:

() Repetitive Rating: Pulse width limited by maximum junction temperature.

(2) Surface Mounted on FR4 Board, t \leq 10 sec.

(3) Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

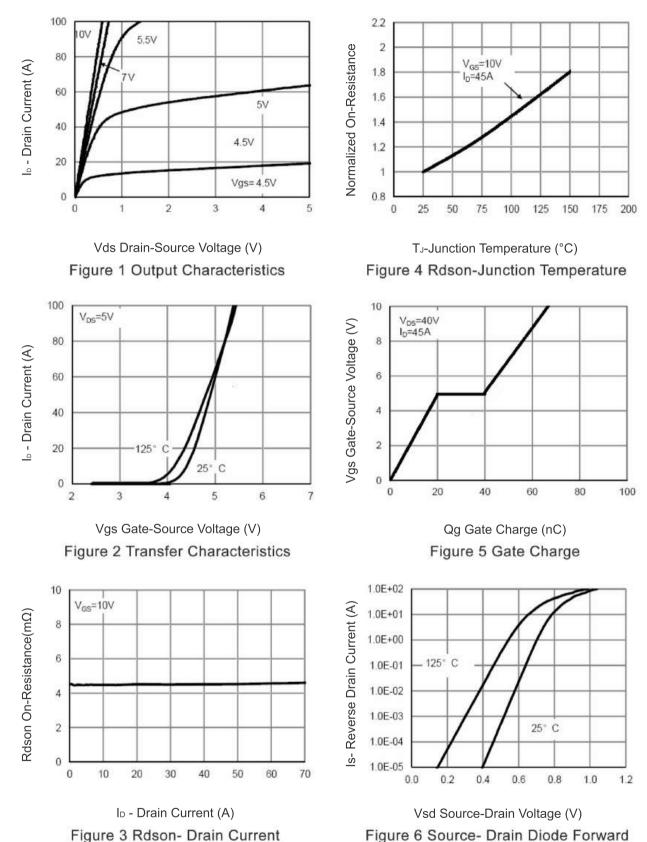
④ Guaranteed by design, not subject to production

(5) EAS condition : Tj=25°C,VDD=40V,VG=10V,L=0.5mH,Rg=25\Omega



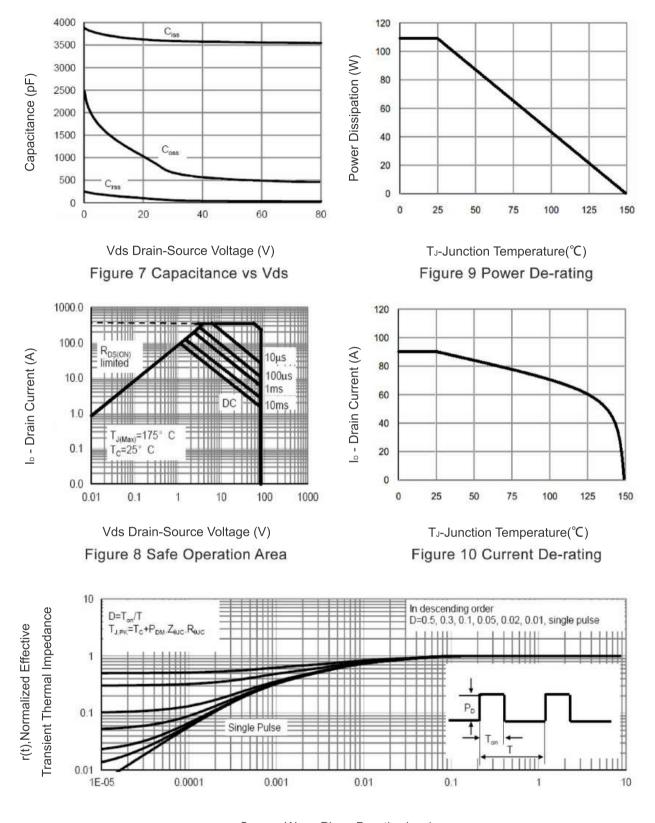


Typical Electrical and Thermal Characteristics









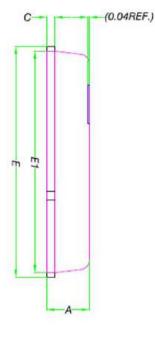
Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance

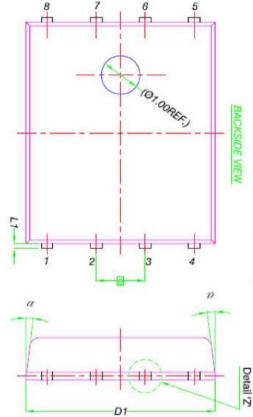


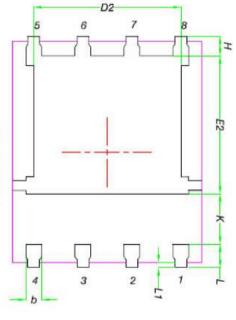


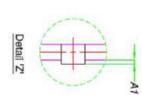
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DFN5X6-8L Package Information

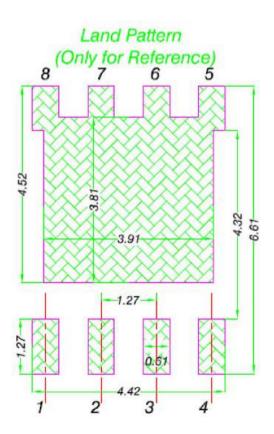








0.04	MILLIMETERS				
DIM.	MIN.	NOM.	MAX.		
Α	0.90	1.00	1.10		
A1	0	•	0.05		
b	0.33	0.41	0.51		
С	0.20	0.25	0.30		
D1	4.80	4.90	5.00		
D2	3.61	3.81	3.96		
Ε	5.90	6.00	6.10		
E1	5.70	5.75	5.80		
E2	3.38	3.58	3.78		
е		1.27 BSC			
Н	0.41	0.51	0.61		
К	1.10	-	•		
L	0.51	0.61	0.71		
L1	0.06	0.13	0.20		
α	0°	-	12		







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